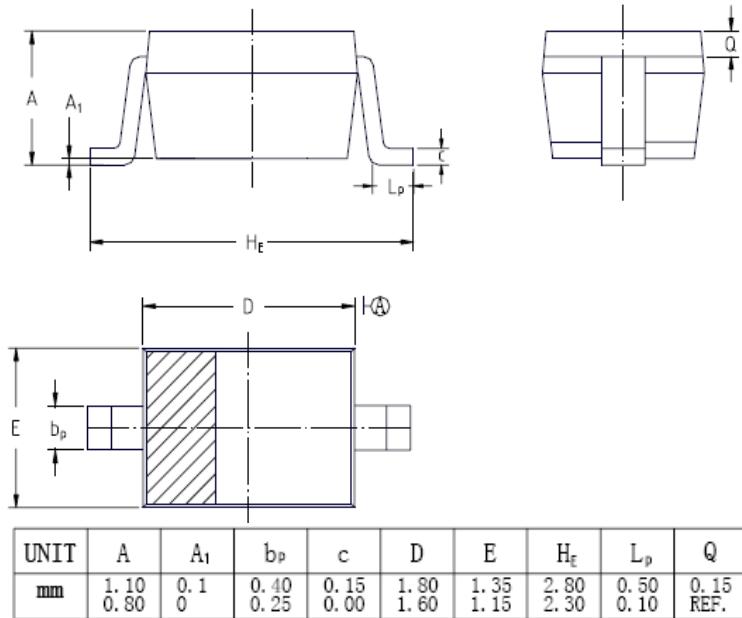


SILICON EPITAXIAL PLANAR SMALL SIGNAL DIODE

FEATURES

- SOD 323 package
- Fast switching
- These diodes are also available in other case style including the DO-35 case with the type designation 1N4148, the MiniMELF case with the type designation LL4148 and the MicroMELF case with the type designation MCL4148.
- Marking: W2

SOD-323**Absolute Maximum Ratings (Ta = 25°C)**

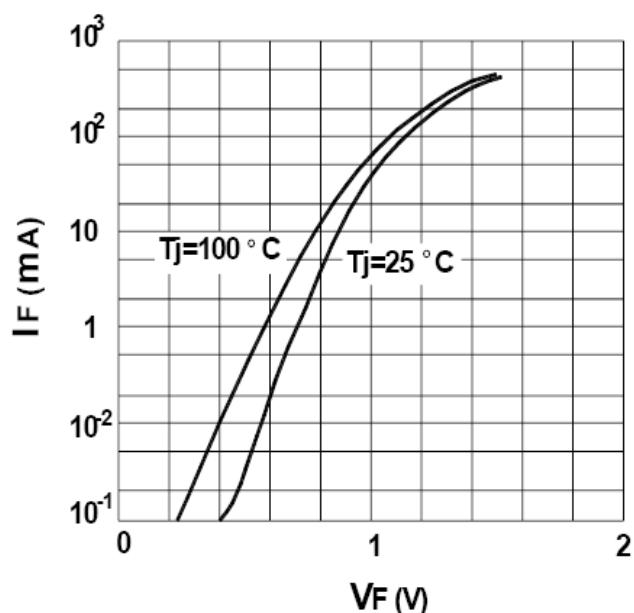
Parameter	Symbol	Limits						Unit
Peak reverse voltage	V _{RM}	100						V
Reverse voltage	V _R	75						V
Average rectified current half wave Rectification with resistive load f ≥ 50Hz	I _{F(AV)}	150*						mA
Surge forward current t<1s T _j = 25 °C	I _{FSM}	350						mA
Power dissipation	P _{tot}	200*						mW
Thermal resistance from junction to ambient air	R _{θJA}	650*						°C/W
Junction temperature	T _J	150						°C
Storage temperature	T _{stg}	-65 to +150						°C

* Valid provided that electrodes are kept at ambient temperature.

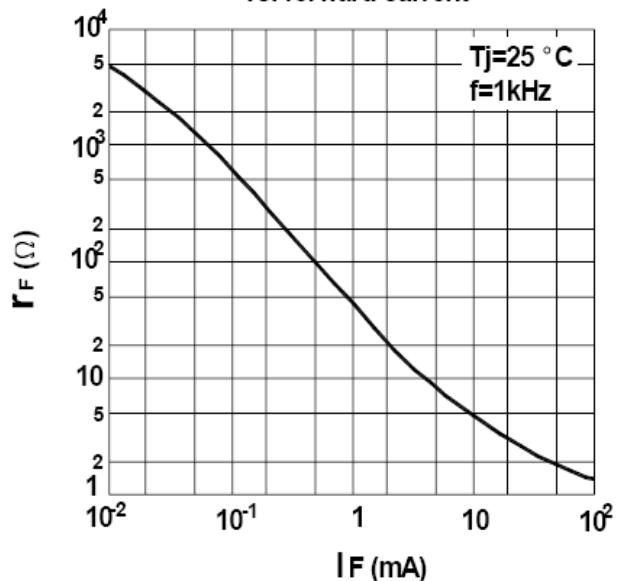
Electrical Characteristics (Ta = 25 °C)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Forward voltage	V _F	-	-	1.0	V	I _F = 10mA
Reverse current	I _R	-	-	25 5.0 50	nA μA μA	V _R = 20V V _R = 75V V _R = 20V, T _J = 150°C
Capacitance	C _{tot}	-	-	4.0	pF	V _F = V _R = 0V
Reverse recovery time	trr	-	-	4.0	ns	V _R = 6V, I _F = 10mA, R _L = 100 Ω, I _R = 1mA,
Voltage rise when switching ON (tested with 50 mA pulse)	V _f r	-	-	2.5	V	t _p = 0.1μs, rise time<30ns, f _p = (5 to 100) kHz
Rectification efficiency	η _V	0.45	-	-	-	f = 100MHz, V _{RF} = 2V

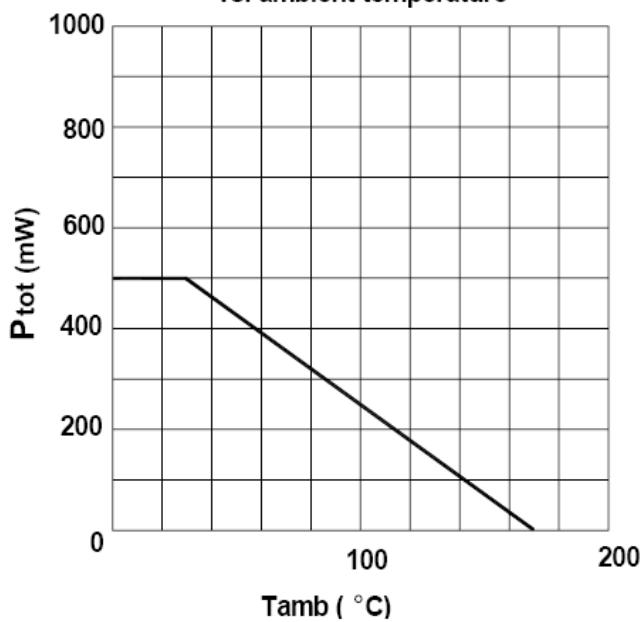
Forward characteristics



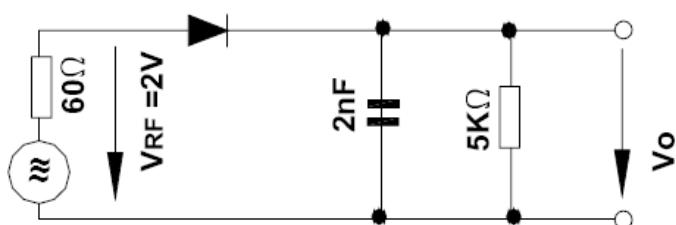
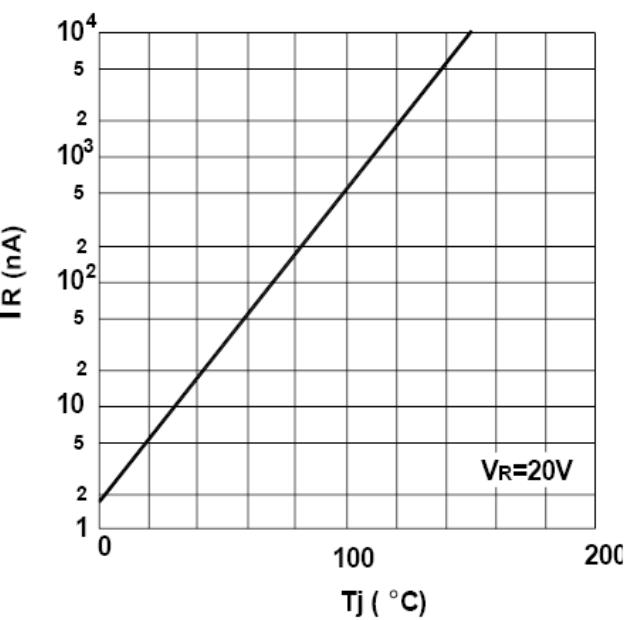
Dynamic forward resistance vs. forward current



Admissible power dissipation vs. ambient temperature

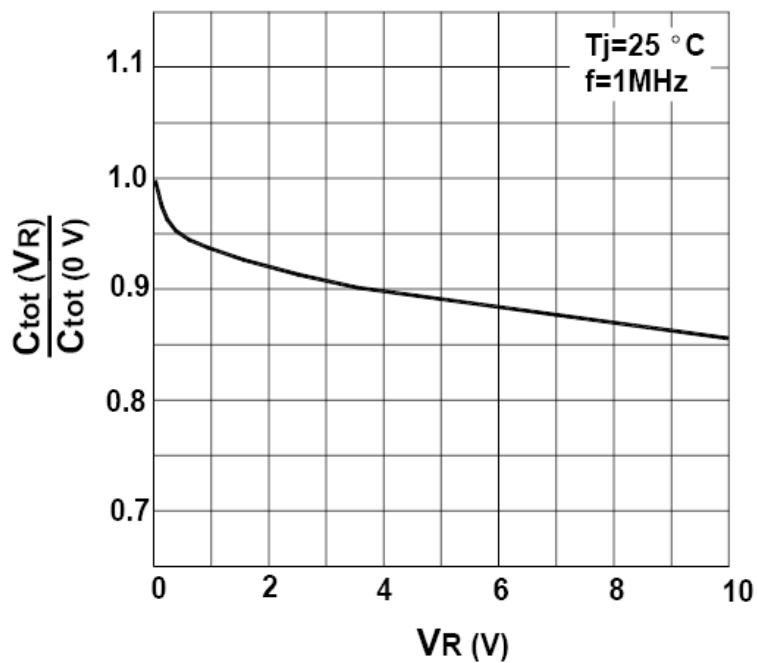


Leakage current vs. junction temperature



Rectification Efficiency Measurement Circuit

Reverse capacitance vs. reverse voltage



Admissible repetitive peak forward current vs. pulse duration

